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Challenges in Mechanics of Biological Systems and Materials, Thermomechanics and Infrared Imaging, Time Dependent Materials and Residual Stress, Volume 2

Proceedings of the 2023 Annual Conference on Experimental and Applied Mechanics

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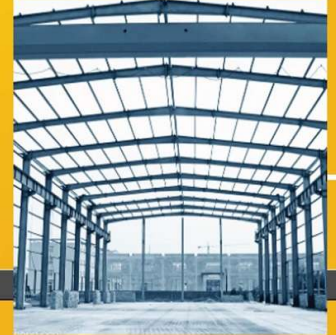
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